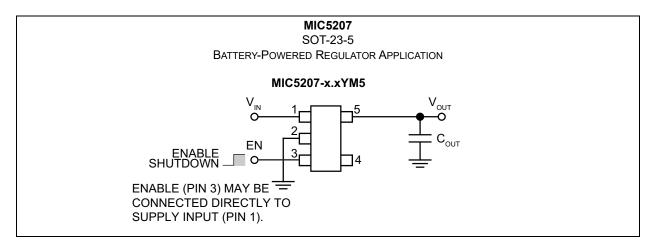
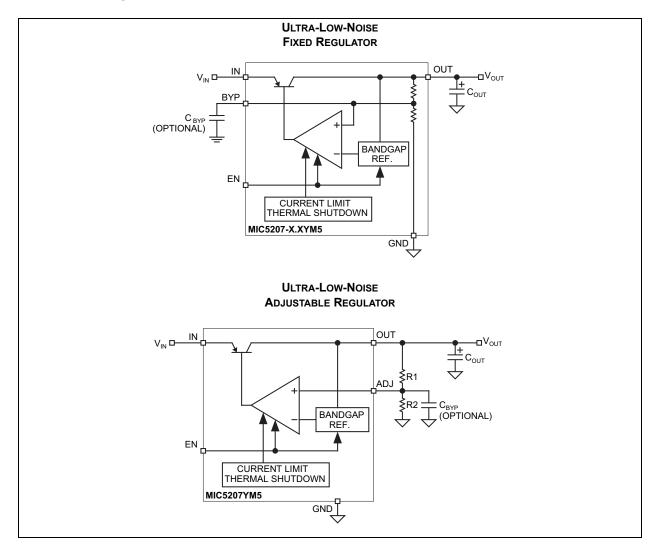
Typical Application Circuit



Functional Diagrams



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Supply Input Voltage (V _{IN})	
Enable Input Voltage (V _{EN})	
Power Dissipation (P _D) (Note 1)	

Operating Ratings ‡

Supply Input Voltage (V _{IN})	+2.5V to +16V
Adjustable Output Voltage Range (V _{OUT})	
Enable Input Voltage (V _{EN})	

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

‡ Notice: The device is not guaranteed to function outside its operating ratings.

Note 1: The maximum allowable power dissipation at any T_A (ambient temperature) is $P_{D(max)} = (T_{J(max)} - T_A) / \theta_{JA}$. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. The θ_{JA} of the SOT-23-5 (M5) is 235°C/W soldered on a PC board (see "Thermal Considerations" for further details).

TABLE 1-1: ELECTRICAL CHARACTERISTICS (Note 1)

Electrical Characteristics: V_{IN} = V_{OUT} + 1V; I_L = 100 μ A; C_L = 1.0 μ F; V_{EN} \geq 2.0V; T_J = +25°C, **bold** values indicate -40°C \leq T_J \leq +125°C except 0°C < T_J < +125°C for 1.8V; unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions	
Output Maltaga Assumance		-3	_	3	%	Variation from nominal V _{OUT}	
Output Voltage Accuracy	V _O	-4	_	4	70		
Output Voltage Temperature Coefficient	ΔV _O /ΔΤ	_	40	_	ppm/°C	Note 2	
Line Regulation	A\/_\/	_	0.005	0.05	%	V = V + 1V/to 16V/	
Line Regulation	$\Delta V_{O}/V_{O}$			0.10		$V_{IN} = V_{OUT} + 1V \text{ to } 16V$	
Load Regulation	$\Delta V_{O}/V_{O}$		0.05	0.5	%	I _I = 0.1 mA to 150 mA, Note 3	
Load Negulation	Δν _Ο /ν _Ο			0.7	/0	1 - 0.1 mA to 130 mA, Note 3	
			17	60		 I _I = 100 μA	
			_	80		Ι[- 100 μΑ	
			115	175		I _I = 50 mA	
Dropout Voltage, Note 4	V _{IN} – V _O		_	250	mV	IL - 30 IIIA	
Diopout voltage, Note 4	v _{IN} – v _O		140	280	1117	I _I = 100 mA	
				325		1 - 100 mA	
			165	300		 I _I = 150 mA	
			—	400		IL - 100 IIIA	
Quiescent Current	1.		0.01	1	μA	V _{EN} ≤ 0.4V (shutdown)	
Quiescent Current	I _{GND}			5	μΑ	V _{EN} ≤ 0.18V (shutdown)	
	I _{GND}		80	130		V _{EN} ≥ 2.0V, I _L = 100 μA	
				170		V _{EN} ≥ 2.0V, I _L = 100 μA	
			350	650		I _L = 50 mA	
Ground Pin Current				900		IL - 30 IIIA	
(Note 5)			720	1100	μA	I ₁ = 100 mA	
		_	_	2000		IL - 100 IIIA	
			1800	2500		I _I = 150 mA	
		_	_	3000		1 - 130 IIIA	
Ripple Rejection	PSRR	_	75	_	dB	_	
Current Limit	I _{LIMIT}		320	500	mA	V _{OUT} = 0V	
Thermal Regulation	$\Delta V_{O}/\Delta P_{D}$		0.05	_	%/W	Note 6	
Output Noise	e _n		100		μV	_	

TABLE 1-1: ELECTRICAL CHARACTERISTICS (Note 1) (CONTINUED)

Electrical Characteristics: V_{IN} = V_{OUT} + 1V; I_L = 100 μ A; C_L = 1.0 μ F; V_{EN} \geq 2.0V; T_J = +25°C, **bold** values indicate -40° C \leq T_J \leq +125°C except 0° C < T_J < +125°C for 1.8V; unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Enable Input	Enable Input							
Enable Input Logic-Low	V	_	_	0.4	V	Pogulator shutdown		
Voltage	V _{IL}			0.18	V	Regulator shutdown		
Enable Input Logic-High Voltage	V _{IH}	2.0	_	_	V	Regulator enable		
	1		0.01	-1		V _{IL} ≤ 0.4V		
Enable Input Current	I₁∟			-2	μΑ	V _{IL} ≤ 0.18V		
	I _{IH}		5	20		V _{IH} ≥ 2.0V		
		_	_	25		V _{IH} ≥ 2.0V		

- **Note 1:** Specification for packaged product only.
 - 2: Output voltage temperature coefficient is defined as the worst-case voltage change divided by the total temperature range.
 - 3: Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1 mA to 180 mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
 - **4:** Dropout Voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.
 - **5:** Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.
 - **6:** Thermal regulation is defined as the change in output voltage at a time "t" after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 180 mA load pulse at V_{IN} = 16V for t = 10 ms.

TEMPERATURE SPECIFICATIONS (Note 1)

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Storage Temperature Range	T _S	-65	_	+150	°C	_
Lead Temperature	_	_	_	+260	°C	Soldering, 5 sec.
Junction Temperature (2.5 ≤ V _{OUT} ≤ 15V)	TJ	-40	_	+125	°C	All, except 1.8V
Junction Temperature (1.8V ≤ V _{OUT} < 2.5V)	TJ	0	_	+125	°C	1.8V only
Package Thermal Resistance						
Thermal Resistance SOT-23	θ_{JA}		235	_	°C/W	_
Thermal Resistance SOT-23	θ_{JC}	_	130	_	[C/VV	_

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

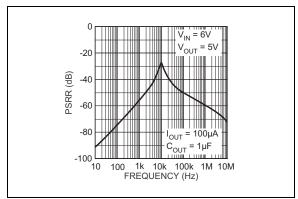


FIGURE 2-1: Power Supply Rejection Ratio.

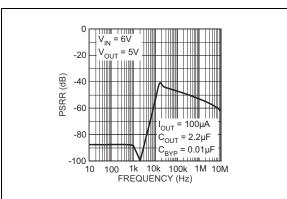


FIGURE 2-2: Power Supply Rejection Ratio.

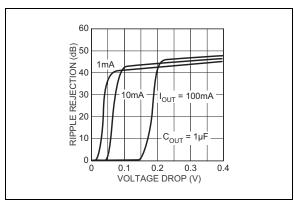


FIGURE 2-3: Power Supply Ripple Rejection vs. Voltage Drop.

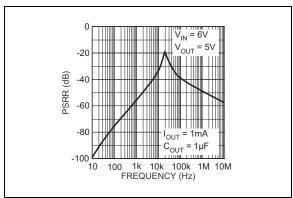


FIGURE 2-4: Power Supply Rejection Ratio.

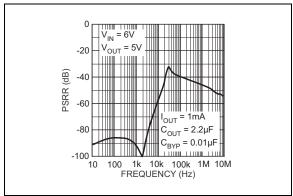


FIGURE 2-5: Power Supply Rejection Ratio.

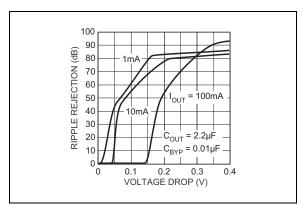


FIGURE 2-6: Power Supply Ripple Rejection vs. Voltage Drop.

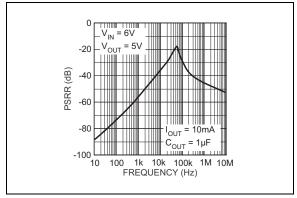


FIGURE 2-7: Ratio.

Power Supply Rejection

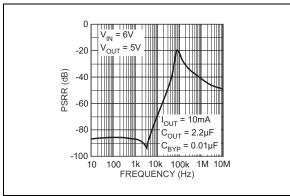


FIGURE 2-8: Ratio.

Power Supply Rejection

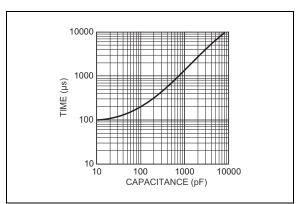


FIGURE 2-9: Capacitance.

Turn-On Time vs. Bypass

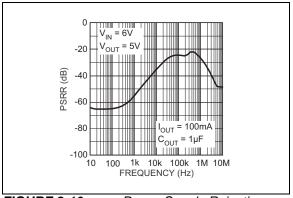


FIGURE 2-10: Ratio.

Power Supply Rejection

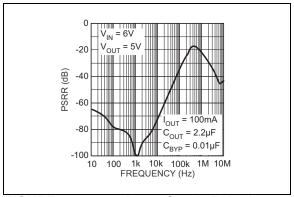


FIGURE 2-11: Ratio.

Power Supply Rejection

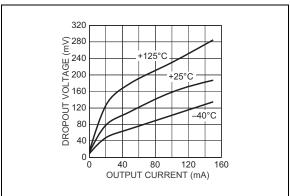


FIGURE 2-12: Current.

Dropout Voltage vs. Output

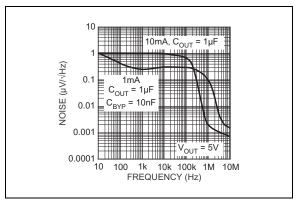


FIGURE 2-13: Noise Performance.

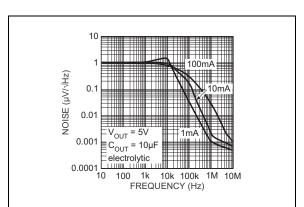


FIGURE 2-14: Noise Performance.

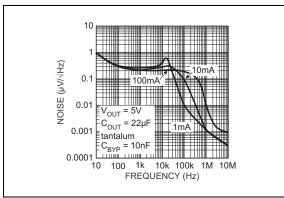


FIGURE 2-15: Noise Performance.

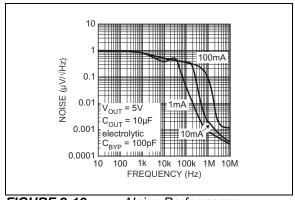


FIGURE 2-16: Noise Performance.

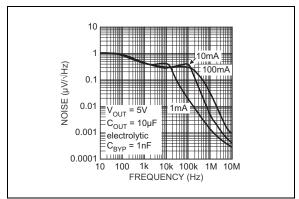


FIGURE 2-17: Noise Performance.

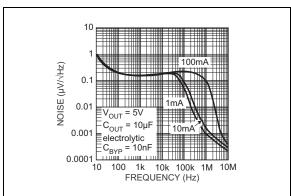


FIGURE 2-18: Noise Performance.

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	IN	Supply input.
2	GND	Ground.
3	EN	Enable/Shutdown (Input): CMOS-compatible input. Logic-high = enable, logic-low = shutdown. Do not leave floating.
4 (Fixed)	BYP	Reference Bypass: Connect external 470 pF capacitor to GND to reduce output noise. May be left open. For 1.8V or 2.5V operation, see Applications Information section.
4 (Adj.)	ADJ	Adjust (Input): Adjustable regulator feedback input. Connect to resistor voltage divider.
5	OUT	Regulator output.

4.0 APPLICATIONS INFORMATION

4.1 Enable/Shutdown

Forcing EN (enable/shutdown) high (> 2V) enables the regulator. EN is compatible with CMOS logic gates.

If the enable/shutdown feature is not required, connect EN (pin 3) to IN (supply input, pin 1). See Figure 4-1.

4.2 Input Capacitor

A 1 μF capacitor should be placed from IN to GND if there is more than 10 inches of wire between the input and the AC filter capacitor or if a battery is used as the input.

4.3 Reference Bypass Capacitor

Reference bypass (BYP) is connected to the internal voltage reference. A 470 pF capacitor (C_{BYP}) connected from BYP to GND quiets this reference, providing a significant reduction in output noise. C_{BYP} reduces the regulator phase margin; when using C_{BYP} , output capacitors of 2.2 μF or greater are generally required to maintain stability.

The start-up speed of the MIC5207 is inversely proportional to the size of the reference bypass capacitor. Applications requiring a slow ramp-up of output voltage should consider larger values of C_{BYP} . Likewise, if rapid turn-on is necessary, consider omitting C_{BYP} .

If output noise is not a major concern, omit $C_{\mbox{\footnotesize{BYP}}}$ and leave BYP open.

4.4 Output Capacitor

An output capacitor is required between OUT and GND to prevent oscillation. The minimum size of the output capacitor is dependent upon whether a reference bypass capacitor is used. 1.0 μF minimum is recommended when C_{BYP} is not used (see Figure 4-2). 2.2 μF minimum is recommended when C_{BYP} is 470 pF (see Figure 4-1). Larger values improve the regulator's transient response. The output capacitor value may be increased without limit.

The output capacitor should have an ESR (effective series resistance) of about 5Ω or less and a resonant frequency above 1 MHz. Ultra-low-ESR (ceramic) capacitors can cause a low amplitude oscillation on the output and/or under-damped transient response. Most tantalum or aluminum electrolytic capacitors are adequate; film types will work, but are more expensive. Since many aluminum electrolytics have electrolytes that freeze at about -30°C , solid tantalums are recommended for operation below -25°C .

At lower values of output current, less output capacitance is required for output stability. The capacitor can be reduced to 0.47 μ F for current below 10 mA or 0.33 μ F for currents below 1 mA.

4.5 No-Load Stability

The MIC5207 will remain stable and in regulation with no load (other than the internal voltage divider) unlike many other voltage regulators. This is especially important in CMOSRAM keep-alive applications.

4.6 Thermal Considerations

The MIC5207 is designed to provide 180 mA of continuous current in a very small package. Maximum power dissipation can be calculated based on the output current and the voltage drop across the part. To determine the maximum power dissipation of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation shown in Equation 4-1:

EQUATION 4-1:

$$P_{D(MAX)} = \frac{(T_{J(MAX)} - T_A)}{\theta_{JA}}$$

 $T_{J(MAX)}$ is the maximum junction temperature of the die, +125°C, and T_A is the ambient operating temperature. θ_{JA} is layout dependent; Table 4-1 shows examples of junction-to-ambient thermal resistance for the MIC5207.

TABLE 4-1: SOT-23-5 THERMAL RESISTANCE

θ _{JA} Rec. Min. Footprint	θ _{JA} 1" Square Copper Clad	θ _{J/C}
235°C/W	170°C/W	130°C/W

The actual power dissipation of the regulator circuit can be determined using Equation 4-2:

EQUATION 4-2:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND}$$

Substituting $P_{D(MAX)}$ for P_{D} and solving for the operating conditions that are critical to the application will give the maximum operating conditions for the regulator circuit. For example, when operating the

MIC5207-3.3YM5 at room temperature with a minimum footprint layout, the maximum input voltage for a set output current can be determined with Equation 4-3:

EQUATION 4-3:

$$P_{D(MAX)} = \frac{125^{o}C - 25^{o}C}{235^{o}C/W} = 425mW$$

The junction-to-ambient thermal resistance for the minimum footprint is 235°C/W , from Table 4-1. The maximum power dissipation must not be exceeded for proper operation. Using the output voltage of 3.3V and an output current of 150 mA, the maximum input voltage can be determined. From Table 1-1, the maximum ground current for 150 mA output current is 3000 μA or 3 mA.

EQUATION 4-4:

$$425mW = (V_{IN} - 3.3V) \times 150mA + V_{IN} \times 3mA$$

Where:

EQUATION 4-5:

$$425 mW = V_{IN} \times 150 mA - 495 mW + V_{IN} \times 3 mA$$

Then:

EQUATION 4-6:

$$920mW = V_{IN} \times 153mA$$

Resulting in:

EQUATION 4-7:

$$V_{IN(MAX)} = 6.01V$$

Therefore, a 3.3V application at 150 mA of output current can accept a maximum input voltage of 6V in a SOT-23-5 package. For a full discussion of heat sinking and thermal effects on voltage regulators, refer to the Regulator Thermals section of Microchip's <u>Designing</u> with Low-Dropout Voltage Regulators handbook.

4.7 Low-Voltage Operation

The MIC5207-1.8 and MIC5207-2.5 require special consideration when used in voltage-sensitive systems. They may momentarily overshoot their nominal output voltages unless appropriate output and bypass capacitor values are chosen.

During regulator power up, the pass transistor is fully saturated for a short time, while the error amplifier and voltage reference are being powered up more slowly from the output (see Functional Diagrams). Selecting larger output and bypass capacitors allows additional time for the error amplifier and reference to turn on and prevent overshoot.

To ensure that no overshoot is present when starting up into a light load (100 μ A), use a 4.7 μ F output capacitance and 470 pF bypass capacitance. This slows the turn-on enough to allow the regulator to react and keep the output voltage from exceeding its nominal value. At heavier loads, use a 10 μ F output capacitance and 470 pF bypass capacitance. Lower values of output and bypass capacitance can be used, depending on the sensitivity of the system.

Applications that can withstand some overshoot on the output of the regulator can reduce the output capacitor and/or reduce or eliminate the bypass capacitor. Applications that are not sensitive to overshoot due to power-on reset delays can use normal output and bypass capacitor configurations.

Please note the junction temperature range of the regulator with an output less than 2.5V fixed and adjustable is 0°C to +125°C.

4.8 Fixed Regulator Applications

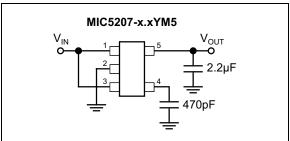


FIGURE 4-1: Ultra-Low-Noise Fixed-Voltage Application.

Figure 4-1 includes a 470 pF capacitor for ultra-low-noise operation and shows EN (pin 3) connected to IN (pin 1) for an application where enable/shutdown is not required. $C_{OUT}=2.2~\mu F$ minimum.

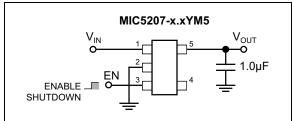


FIGURE 4-2: Low-Noise Fixed-Voltage Application.

Figure 4-2 is an example of a basic low-noise configuration. C_{OUT} = 1 μF minimum.

4.9 Adjustable Regulator Applications

The MIC5207YM5 can be adjusted to a specific output voltage by using two external resistors (Figure 4-3). The resistors set the output voltage based on Equation 4-8:

EQUATION 4-8:

$$V_{OUT} = V_{REF} \times \left(1 + \frac{R2}{R1}\right) = 1.242 V \times \left(1 + \frac{R2}{R1}\right)$$

This equation is correct due to the configuration of the bandgap reference. The bandgap voltage is relative to the output, as seen in the Functional Diagrams. Traditional regulators normally have the reference voltage relative to ground; therefore, their equations are different from the equation for the MIC5207YM5.

Resistor values are not critical because ADJ (adjust) has a high input impedance, but for best results use resistors of 470 k Ω or less. A capacitor from ADJ to ground provides greatly improved noise performance.

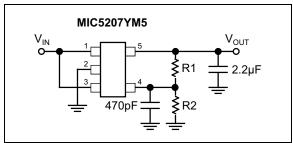


FIGURE 4-3: Ultra-Low-Noise Adjustable-Voltage Application.

Figure 4-3 includes the optional 470 pF noise bypass capacitor from ADJ to GND to reduce output noise.

4.10 Dual-Supply Operation

When used in dual-supply systems where the regulator load is returned to a negative supply, the output voltage must be diode clamped to ground.

4.11 USB Application

Figure 4-4 shows the MIC5207-3.3YM5 in a USB application. Because the V_{BUS} supply may be greater than 10 inches from the regulator, a 1 μF input capacitor is included.

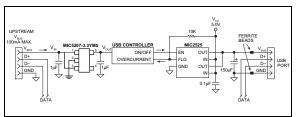


FIGURE 4-4: Single-Port Self-Powered Hub.

5.0 PACKAGING INFORMATION

5.1 Package Marking Information

 XXXX
 LE50

 NNN
 943

 5-Pin TSOT*
 Example

 XXXX
 NA18

 NNN
 235

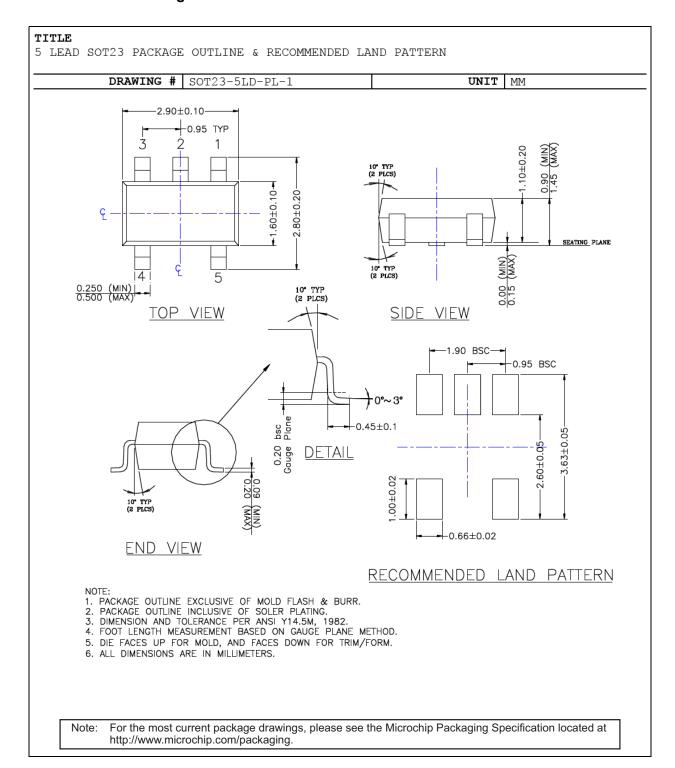
Legend: XX...X Product code or customer-specific information
Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code
② Pb-free JEDEC® designator for Matte Tin (Sn)
This package is Pb-free. The Pb-free JEDEC designator (②)
can be found on the outer packaging for this package.

•, ▲, ▼ Pin one index is identified by a dot, delta up, or delta down (triangle mark).

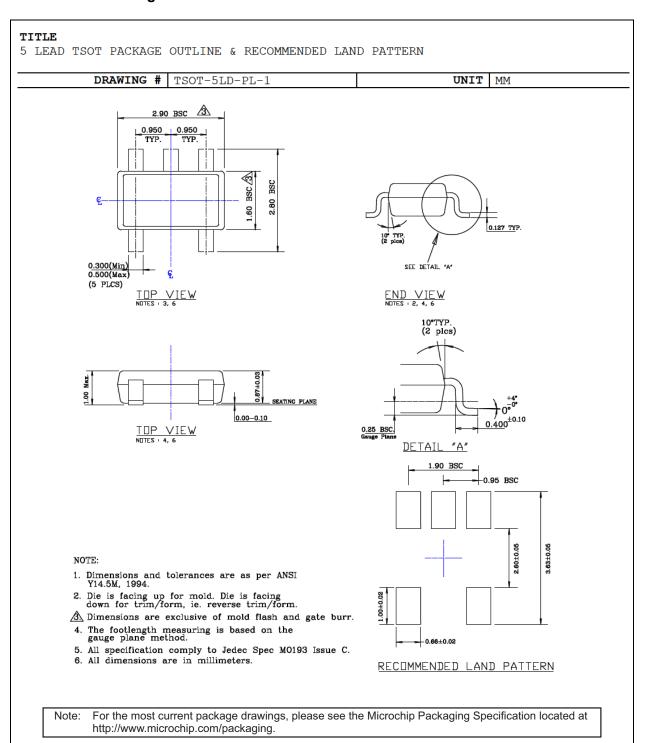
Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.

Underbar (_) and/or Overbar (¯) symbol may not be to scale.

5-Lead SOT-23 Package Outline and Recommended Land Pattern



5-Lead TSOT Package Outline and Recommended Land Pattern



APPENDIX A: REVISION HISTORY

Revision A (February 2017)

- Converted Micrel document MIC5207 to Microchip data sheet DS20005719A.
- · Minor text changes throughout.
- Removed all reference to discontinued leaded parts.
- Added θ_{JC} value for SOT-23 package in Temperature Specifications section.

Revision B (September 2018)

Updated to Revision 20005719B by revising Equation 4-8 to improve productivity.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

DARTNO		Examples:
PART NO Device	T T T	a) MIC5207-1.8YD5-TR: 180 mA Low-Noise LDO Regulator, 1.8V Voltage, 5-Lea TSOT, -40°C to +125°C Temperature Range, 3,000/Reel
Voltage:	(blank) = Adjustable 1.8 = 1.8V 2.5 = 2.5V 2.8 = 2.8V	b) MIC5207-2.5YM5-TR: 180 mA Low-Noise LDO Regulator, 2.5V Voltage, 5-Lea SOT-23, -40°C to +125°C Temperature Range, 3,000/Reel
	2.9 = 2.9V 3.0 = 3.0V 3.1 = 3.1V 3.2 = 3.2V 3.3 = 3.3V 4.0 = 4.0V 5.0 = 5.0V	c) MIC5207-2.5YM5-TX: 180 mA Low-Noise LDO Regulator, 2.5V Voltage, 5-Lea SOT-23, -40°C to +125°C Temperature Range, 3,000/Reel (Reverse Pin 1)
Temperature:	$Y = -40^{\circ}C \text{ to } +125^{\circ}C$ $D5 = 5\text{-Lead TSOT}$	d) MIC5207YM5-TR: 180 mA Low-Noise LDO Regulator, Adj. Voltage, 5-Lea SOT-23, -40°C to +125°C Temperature Range, 3,000/Reel
Media Type:	M5 = 5-Lead SOT-23 TR = 3,000/Reel TX = 3,000/Reel (Reverse Pin 1 Orientation)	e) MIC5207-2.9YM5-TR: 180 mA Low-Noise LDO Regulator, 2.9V Voltage, 5-Lea SOT-23, -40°C to +125°C Temperature Range, 3,000/Reel
		f) MIC5207-3.1YM5-TR: 180 mA Low-Noise LDO Regulator, 3.1V Voltage, 5-Lea SOT-23, -40°C to +125°C Temperature Range, 3,000/Reel
		g) MIC5207-5.0YM5-TR: 180 mA Low-Noise LDO Regulator, 5.0V Voltage, 5-Lea SOT-23, -40°C to +125°C Temperature Range, 3,000/Reel
		h) MIC5207-3.3YM5-TX: 180 mA Low-Noise LDO Regulator, 3.3V Voltage, 5-Lea SOT-23, -40°C to +125°C Temperature Range, 3,000/Reel (Reverse Pin 1)
		Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

NOTES:

Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
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ISBN: 978-1-5224-3498-6



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